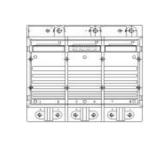
SKiiP 632GB120-315CTV ...



SKiiP[®] 2

2-pack - integrated intelligent Power System

Power section

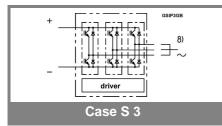
SKiiP 632GB120-315CTV

Features

- SKiiP technology inside
- Low loss IGBTs
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP[®] 2 System)
- IEC 68T.1 (climate) 40/125/56 (SKiiP[®] 2 power section)
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)
- AC connection busbars must be connected by the user; copper busbars available on request

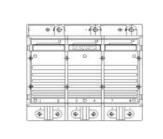
Absolute Maximum Ratings		$_{\rm s}$ = 25 °C unless otherwise specified				
Symbol	Conditions	Values	Units			
IGBT						
V _{CES}		1200	V			
V _{CC} ¹⁾	Operating DC link voltage	900	V			
V _{GES}		± 20	V			
I _C	T _s = 25 (70) °C	600 (450)	А			
Inverse diode						
I _F = - I _C	T _s = 25 (70) °C	600 (450)	А			
I _{FSM}	T _j = 150 °C, t _p = 10 ms; sin.	4320	А			
I²t (Diode)	Diode, T _j = 150 °C, 10 ms	93	kA²s			
T _j , (T _{stg})		- 40 (- 25) + 150 (125)	°C			
V _{isol}	AC, 1 min. (mainterminals to heat sink)	3000	V			

Characteristics T _s = 25 °						C unless otherwise specified			
Symbol	ymbol Conditions				min.	typ.	max.	Units	
IGBT									
V _{CEsat}		λ, Τ _j = 25 (1	25) °C			2,6 (3,1)	3,1	V	
V _{CEO}	T _j = 25 (12						1,5 (1,6)	V	
r _{CE}	$T_{j} = 25 (12)$					2,5 (3,3)	3 (3,8)	mΩ	
I _{CES}	V_{GE} = 0 V	, $V_{CE} = V_{CE}$	s,			(30)	1,2	mA	
	T _j = 25 (12	25) °C							
E _{on} + E _{off}	I _C = 525 A	, V _{CC} = 600	V C				158	mJ	
	T _j = 125 °	C, V _{CC} = 90	00 V				278	mJ	
R _{CC' + EE'}	terminal c	hip, T _i = 12	5 °C			0,17		mΩ	
L _{CE}	top, bottor	n				5		nH	
C _{CHC}	per phase	, AC-side				4,2		nF	
Inverse diode									
$V_F = V_{EC}$			25) °C			2,1 (2)	2,6	V	
V _{TO}	T _j = 25 (12	25) °C				1,3 (1)	1,4 (1,1)	V	
	T _j = 25 (12	25) °C				1,7 (2)	2,3 (2,6)	mΩ	
Err	I _C = 525 A	, V _{CC} = 600) V				18	mJ	
	T _j = 125 °	C, V _{CC} = 90	V 00				23	mJ	
Mechani	cal data								
M _{dc}	DC termin	als, SI Unit	s		6		8	Nm	
M _{ac}	AC termin	als, SI Unit	s		13		15	Nm	
w	SKiiP [®] 2 System w/o heat sink				2,7		kg		
w	heat sink					6,6		kg	
Thermal	characte	eristics (P16 hea	t sink; 29	95 m ³ /h);	; " _, " refer	ence to		
temperat	ure sens	sor				•			
R _{th(j-s)I}	per IGBT						0,043	K/W	
R _{th(j-s)D}	per diode						0,125	K/W	
$R_{th(s-a)}$	per modul	е					0,036	K/W	
Z _{th}	R _i (mK/W) (max. values)				tau _i (s)				
	1	2	3	4	1	2	3	4	
Z _{th(j-r)I}	5	33	5		1	0,13	0,001		
Z _{th(j-r)D}	14	96	15		1	0,13	0,001		
Z _{th(r-a)}	11,1	18,3	3,5	3,1	204	60	6	0,02	



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SKiiP 632GB120-315CTV ...



SKiiP[®] 2

2-pack - integrated intelligent Power System

2-pack integrated gate driver

SKiiP 632GB120-315CTV

Gate driver features

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)Power supply protected against
- under voltage
- Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 68T.1 (climate) 25/85/56 (SKiiP[®] 2 gate driver)

Absolute Maximum Ratings					
Symbol	Conditions	Values	Units		
V _{S1}	stabilized 15 V power supply	18	V		
V _{S2}	unstabilized 24 V power supply	30	V		
V _{iH}	input signal voltage (high)	15 + 0,3	V		
dv/dt	secondary to primary side	75	kV/μs		
V _{isollO}	input / output (AC, r.m.s., 2s)	3000	Vac		
V _{isol12}	output 1 / output 2 (AC, r.m.s., 2s)	1500	Vac		
f _{max}	switching frequency	20	kHz		
T _{op} (T _{stg})	operating / storage temperature	- 25 + 85	°C		

Characteristics (T _a =					= 25 °C)
Symbol	Conditions	min.	typ.	max.	Units
V _{S1}	supply voltage stabilized	14,4	15	15,6	V
V _{S2}	supply voltage non stabilized	20	24	30	V
I _{S1}	V _{S1} = 15 V	260+450	260+450*f/f _{max} +1,3*(I _{AC} /A)		
I _{S2}	V _{S2} = 24 V	200+300	200+300*f/f _{max} +1,0*(I _{AC} /A)		
V _{iT+}	input threshold voltage (High)	11,2			V
V _{iT-}	input threshold voltage (Low)			5,4	V
R _{IN}	input resistance		10		kΩ
t _{d(on)IO}	input-output turn-on propagation time		1,2		μs
t _{d(off)IO}	input-output turn-off propagation time		1,6		μs
t _{pERRRESET}	error memory reset time	9			μs
t _{TD}	top / bottom switch : interlock time		3,3		μs
I _{analogOUT}	8 V corresponds to max. current of 15 V supply voltage		600		A
I _{Vs1outmax}	(available when supplied with 24 V)			50	mA
I _{A0max}	output current at pin 12/14			5	mA
V _{0I}	logic low output voltage			0,6	V
V _{0H}	logic high output voltage			30	V
I _{TRIPSC}	over current trip level (I _{analog OUT} = 10 V)		750		А
I _{TRIPLG}	ground fault protection				A
T _{tp}	over temperature protection	110		120	°C
U _{DCTRIP}	trip level of U _{DC} -protection	900			V
	$(U_{analog OUT} = 9 V); (option)$				

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